

# MAZYxxx Series (MA1Zxxx Series)

## Silicon planar type

For stabilization of power supply

### ■ Features

- Large power dissipation  $P_D$ : 1 W
- Zener voltage  $V_Z$ : 4.7 V to 51 V
- Zener voltage allowable deviation: 10%
- Auto mounting possible

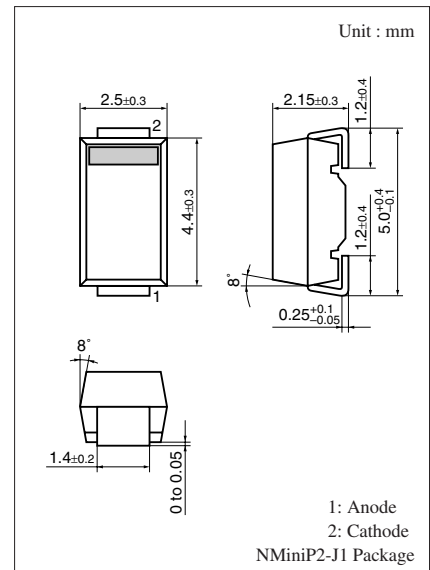
### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Repetitive peak forward current	$I_{FRM}$	500	mA
Power dissipation *1	$P_D$	1.0	W
Non-repetitive reverse surge power dissipation *2	$P_{ZSM}$	100	W
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-40 to +150	$^\circ\text{C}$

Note) \*1:  $P_D = 1.0$  W achieved with a printed circuit board (alumina)

$t = 50 \mu\text{s}$  for the product of  $V_Z \leq 6.8$  V

\*2:  $t = 100 \mu\text{s}$ ,  $T_j = 150^\circ\text{C}$



### Marking Symbol

Refer to the list of the electrical characteristics within part numbers

(Example) MAZY047: 4.7

### ■ Common Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$ \*1

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	$V_F$	$I_F = 200$ mA			1.2	V
Zener voltage *2	$V_Z$	$I_Z$ Specified value				V
Zener operating resistance	$R_Z$	$I_Z$ Specified value				$\Omega$
Reverse current	$I_R$	$V_R$ Specified value				$\mu\text{A}$
Temperature coefficient of zener voltage *3	$S_Z$	$I_Z$ Specified value				mV/ $^\circ\text{C}$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 5 MHz.

3. \*1: The temperature must be controlled  $25^\circ\text{C}$  for  $V_Z$  measurement.

$V_Z$  value measured at other temperature must be adjusted to  $V_Z (25^\circ\text{C})$

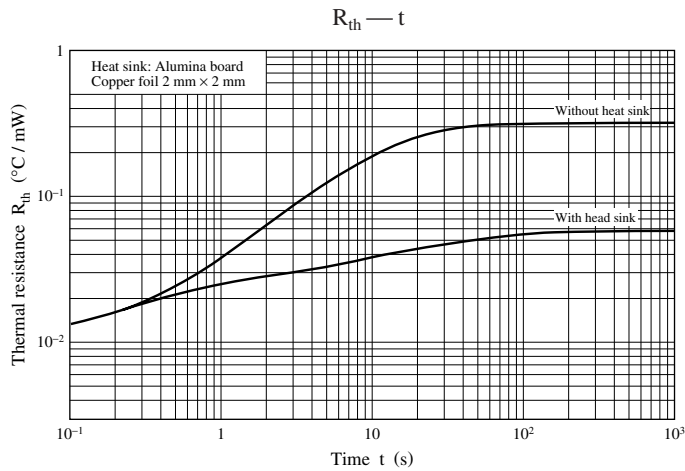
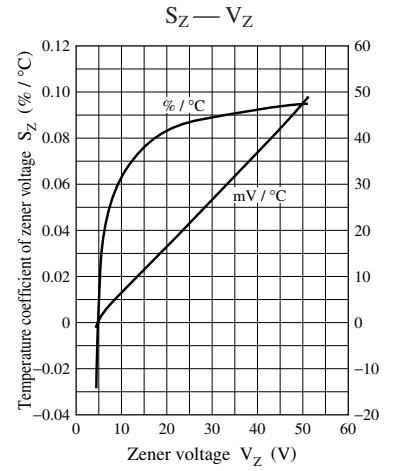
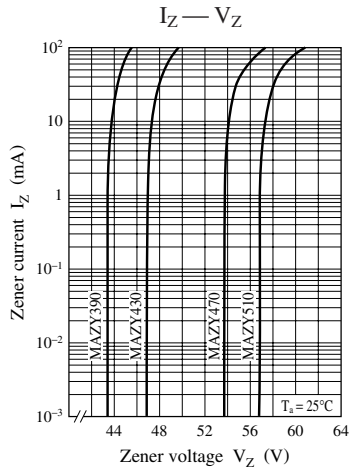
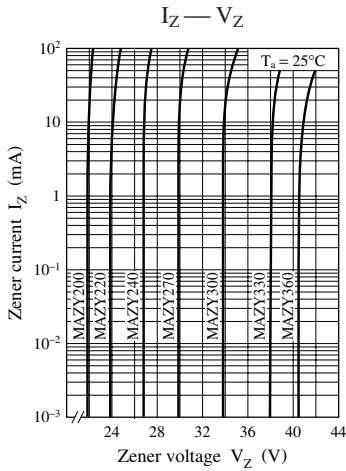
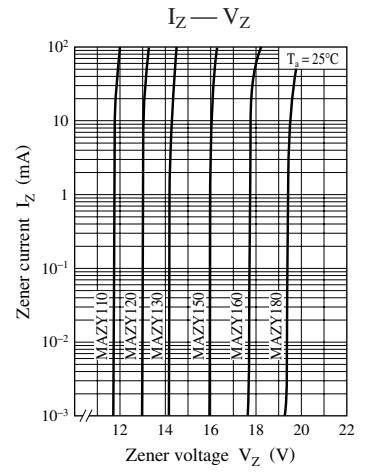
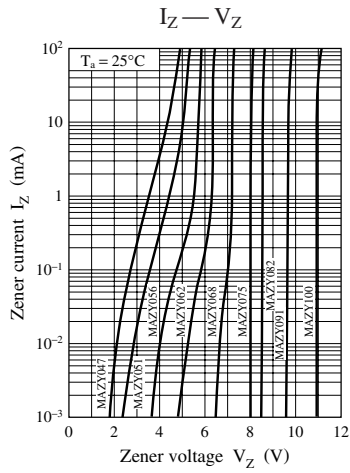
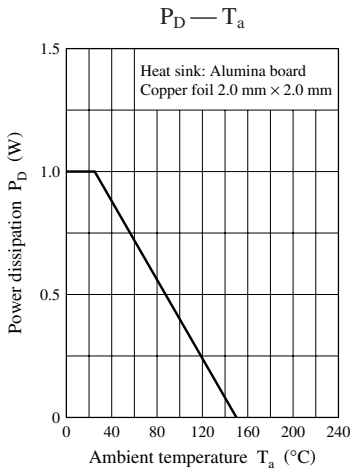
\*2:  $V_Z$  guaranteed 20 ms after current flow.

\*3:  $T_j = 25^\circ\text{C}$  to  $150^\circ\text{C}$

Note) The part number in the parenthesis shows conventional part number.

■ Electrical Characteristics within Part Numbers  $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Part number	Zener voltage				Reverse current		Zener operating resistance		Temperature coefficient of zener voltage		Marking symbol
	$V_Z$ (V)				$I_R$ ( $\mu\text{A}$ )		$R_Z$ ( $\Omega$ )		$S_Z$ (mV/ $^\circ\text{C}$ )		
	Min	Nom	Max	$I_Z$ (mA)	Max	$V_R$ (V)	Max	$I_Z$ (mA)	Typ	$I_Z$ (mA)	
MAZY047	4.4	4.7	5.0	20	40	1.0	60	20	0	20	4.7
MAZY051	4.8	5.1	5.4	20	20	1.0	50	20	0	20	5.1
MAZY056	5.2	5.6	6.0	20	20	2.0	40	20	1.5	20	5.6
MAZY062	5.6	6.2	6.8	10	20	3.0	30	10	2.4	10	6.2
MAZY068	6.2	6.8	7.4	10	10	3.0	30	10	3.1	10	6.8
MAZY075	6.8	7.5	8.3	10	10	3.0	30	10	3.8	10	7.5
MAZY082	7.4	8.2	9.1	10	10	4.0	30	10	4.5	10	8.2
MAZY091	8.2	9.1	10.1	10	10	5.0	30	10	5.4	10	9.1
MAZY100	9.0	10.0	11.0	10	10	7.0	30	10	6.3	10	10
MAZY110	9.9	11.0	12.1	10	10	7.0	30	10	7.4	10	11
MAZY120	10.8	12.0	13.2	10	10	8.0	30	10	8.4	10	12
MAZY130	11.7	13.0	14.3	10	10	9.0	30	10	9.4	10	13
MAZY150	13.5	15.0	16.5	10	10	10.0	30	10	11.4	10	15
MAZY160	14.4	16.0	17.6	10	10	11.0	30	10	12.5	10	16
MAZY180	16.2	18.0	19.8	10	10	13.0	30	10	14.5	10	18
MAZY200	18.0	20.0	22.0	10	10	14.0	30	10	16.6	10	20
MAZY220	19.8	22.0	24.2	10	10	16.0	30	10	18.6	10	22
MAZY240	21.6	24.0	26.4	10	10	17.0	30	10	20.7	10	24
MAZY270	24.3	27.0	29.7	10	10	19.0	30	10	23.8	10	27
MAZY300	27.0	30.0	33.0	10	10	21.0	30	10	26.9	10	30
MAZY330	29.7	33.0	36.3	10	10	26.4	30	10	30.0	10	33
MAZY360	32.4	36.0	39.6	5	10	28.8	30	5	33.4	5	36
MAZY390	35.1	39.0	42.9	5	10	31.8	65	5	36.3	5	39
MAZY430	38.7	43.0	47.3	5	10	35.8	65	5	41.1	5	43
MAZY470	42.3	47.0	51.7	5	10	37.6	65	5	44.9	5	47
MAZY510	45.9	51.0	56.1	5	10	40.8	65	5	48.6	5	51



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